## 1 Implementation of Flip-Flop D and SR Latch with discrete logic gates

Using the schematic on Figure 1 the logic gates were implemented on a PCB.

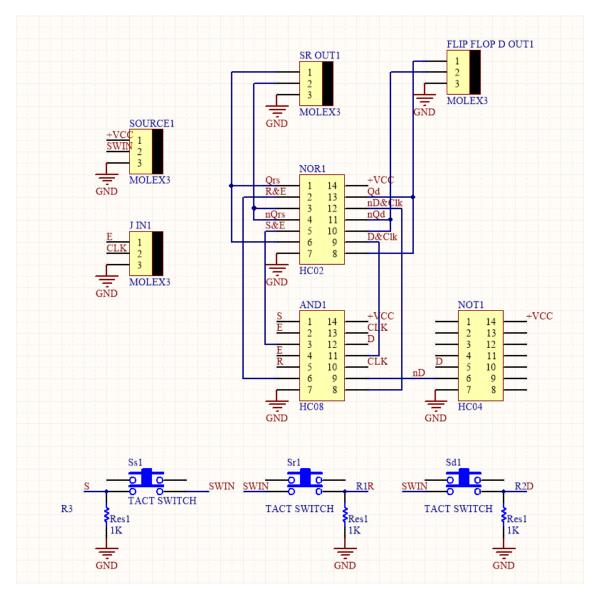


Figure 1: Schematic of the SR Latch (on the left) and Flip-Flop D (on the right)

The resulting circuits were tested and compared to their resulting counterparts as shown in Table 1 and Table 2.

First, in Table 1 we can see that the operating conditions of the circuit are vastly different: We can see that, for example,  $V_{CC}$  has a wider operating range in the experimental circuit than the Integrated circuit it is compared to. The fact that the fabricated circuit was made from more modern components than the SN54279 might account for this difference in operating conditions. On the other hand, the phase differences are fairly similar for both circuits.

Second, in Table 2 there are notable differences on the characteristics of the circuit: the operating voltages are clearly different from those of its commercial counterpart, and the delays between the input and output signals are significantly higher. Given that the fabricated device has wires between each logic gate, it is expected that signals would take longer to travel between each com-

Symbol	Parameter	MIN	SN5427   N/T	9 MAX	Exp MIN	perimer N/T	ntal MAX	Unit
$V_{CC} \ V_{IH}$	Supply Voltage High-level input voltage	4.75	5 -	5.25	0.7 3.79	5	?	V V
$V_{IL}$	Low-level input voltage	_	-	0.8	-	-	$1.35^{1}$	V
$egin{array}{c} V_{OH} \ V_{OL} \end{array}$	High-level output voltage Low-level output voltage	$\begin{vmatrix} 2.4 \\ - \end{vmatrix}$	$\begin{array}{ c c }\hline 3.4\\ 0.2\\ \end{array}$	-0.4	3.88	$\begin{bmatrix} 5 \\ 0 \end{bmatrix}$	- 0.06	V V
$\begin{vmatrix} t_{pHL} \\ t_{pLH} \end{vmatrix}$	Phase Difference Phase Difference		$\begin{array}{ c c } & 9 \\ 12 \end{array}$	15 22	_	-	10 20	ns ns

Table 1: Comparison of measured circuit characteristics for the Latch SR

Symbol	Parameter	74HC74			Ex	Unit		
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply Voltage	2	5	6	1.5	5	?	V
$V_{IH}$	High-level input voltage	3.15	_	_	2.64	_	_	V
$V_{IL}$	Low-level input voltage	_	_	1.35	_	_	2.57	V
$V_I$	Input voltage	0	_	$V_{CC}$	0	_	$V_{CC}$	V
$V_O$	Output voltage	0	_	$V_{CC}$	-0.2	_	$V_{CC}$	V
$\Delta t/\Delta v$	Input rise and fall time	_	_	0.5	_	_	16.05	$\mu \mathrm{s}$
$V_{OH}$	High-level output voltage	3.84	4.3	_	3,725	$V_{CC}$	_	V
$V_{OL}$	Low-level output voltage	_	0.17	0.4	–	-0.2	1.09	V
$t_{pd}$	Phase Difference	-	20	44	_	28	56	ns

Table 2: Comparison of measured circuit characteristics for the Flip-Flop D

ponent; therefore, the delay between the input signal and the output signal will be longer in the experimental circuit than in an Integrated Circuit.

From the differences observed in both devices, one can conclude that both experimentally fabricated devices can be used interchangeably with their commercially available counterparts as long as they are not used in highly time-sensitive conditions. Otherwise, when one is working with signals at the order of MHz it is adviced to use the commercially available equivalents.